# 1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 3 A
- Reverse voltage: V<sub>R</sub> ≤ 40 V
- · Low forward voltage
- · High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- High temperature T<sub>i</sub> ≤ 175 °C
- Suitable for both reflow and wave soldering
- Qualified according to AEC-Q101 and recommended for use in automotive applications

# 3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection
- Low power consumption applications
- · High temperature applications

### 4. Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 165 °C	-	-	3	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	40	٧
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C	-	430	490	mV
I <sub>R</sub>	reverse current	$V_R = 40 \text{ V}; T_j = 25 \text{ °C}$	-	35	200	μA



# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		K <del>_[C </del> -A
2	А	anode	1 2 CFP5 (SOD128)	sym001

[1] The marking bar indicates the cathode.

# 6. Ordering information

### **Table 3. Ordering information**

Type number	Package				
	Name	Description	Version		
PMEG4030ETP-Q	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128		

# 7. Marking

### Table 4. Marking codes

Type number	Marking code
PMEG4030ETP-Q	C3

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	40	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 85 °C	[1]	-	3	Α
		$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 165 °C		-	3	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; half-sine wave; $T_{j(init)}$ = 25 °C		-	50	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	750	mW
			[3]	-	1.25	W
			[1]	-	2.5	W
T <sub>j</sub>	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

PMEG4030ETP-Q

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	1	[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

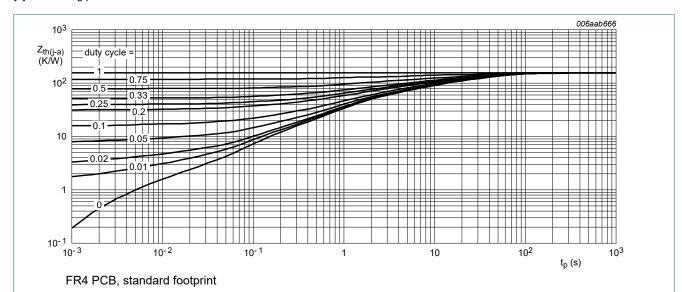


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

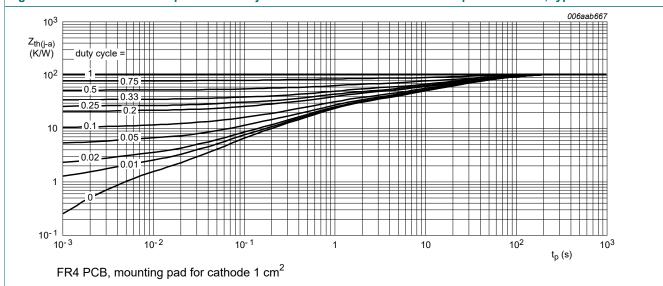
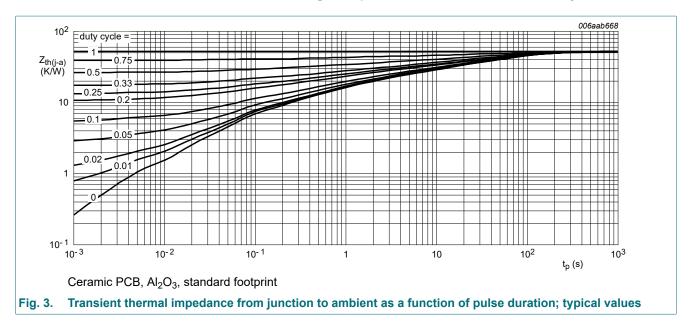


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



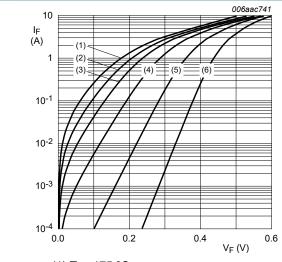
## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	285	320	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	360	420	mV
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C	-	430	490	mV
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 125 °C	-	330	380	mV
I <sub>R</sub> reverse c	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	7	-	μΑ
		V <sub>R</sub> = 40 V; T <sub>j</sub> = 25 °C	-	35	200	μΑ
		V <sub>R</sub> = 10 V; T <sub>j</sub> = 125 °C	-	6	-	mA
	$V_{R} = 40 \text{ V};$	V <sub>R</sub> = 40 V; T <sub>j</sub> = 125 °C	-	23	-	mA
C <sub>d</sub> di	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	350	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	140	-	pF

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### High temperature 40 V, 3 A low VF Schottky barrier rectifier



(1)  $T_j = 175 \,^{\circ}C$ 

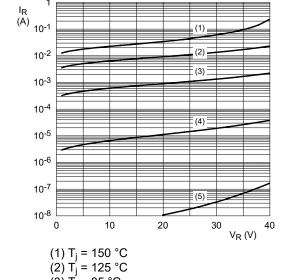
(2)  $T_i = 150 °C$ 

 $(3) T_i = 125 °C$ 

(4)  $T_i = 85$  °C

(5)  $T_j = 25 °C$ (6)  $T_i = -40 °C$ 

Fig. 4. Forward current as a function of forward voltage; typical values



(3)  $T_j = 85 \,^{\circ}\text{C}$ 

 $(4) T_j = 25 °C$ 

 $(5) T_j = -40 ^{\circ}C$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values

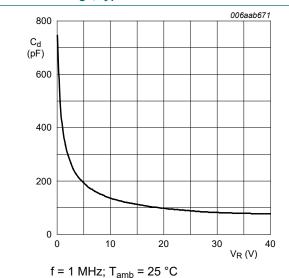
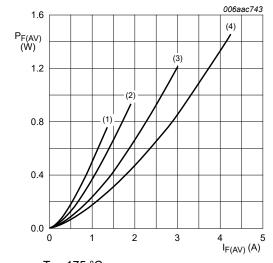


Fig. 6. Diode capacitance as a function of reverse

voltage; typical values



T<sub>i</sub> = 175 °C

 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

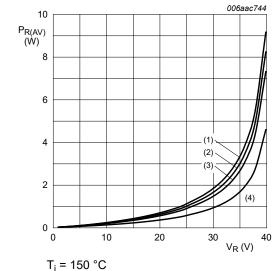
 $(3) \delta = 0.5$ 

 $(3) \delta = 0.3$  $(4) \delta = 1.0$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

**Product data sheet** 

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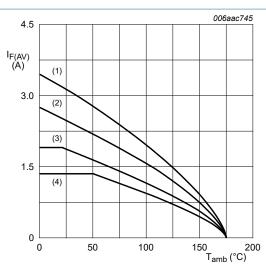


 $(1) \delta = 1.0$ 

 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$  $(4) \delta = 0.5$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

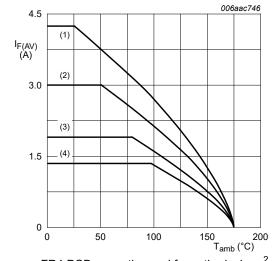
 $(1) \delta = 1.0 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

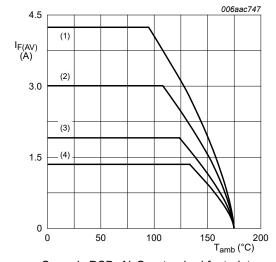
T<sub>i</sub> = 175 °C

 $(1) \delta = 1.0$ 

 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$  $(4) \delta = 0.5$ 

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 175 °C

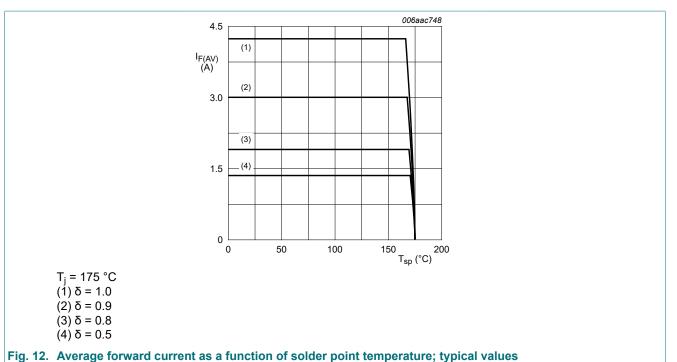
 $(1) \delta = 1.0 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

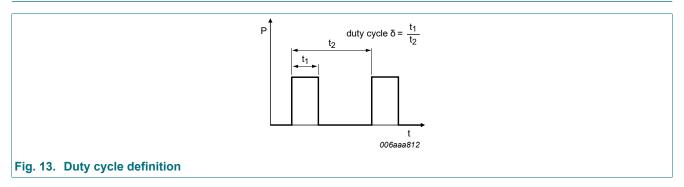
(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



## 11. Test information



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

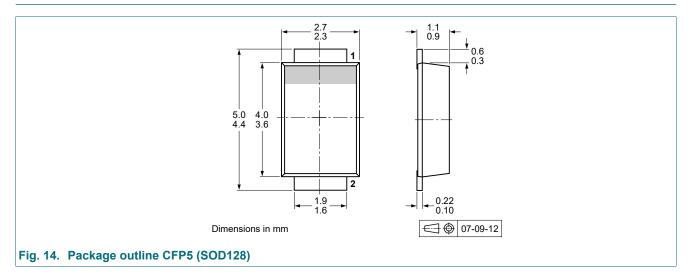
 $I_{RMS}=I_{F(AV)}$  at DC

 $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current

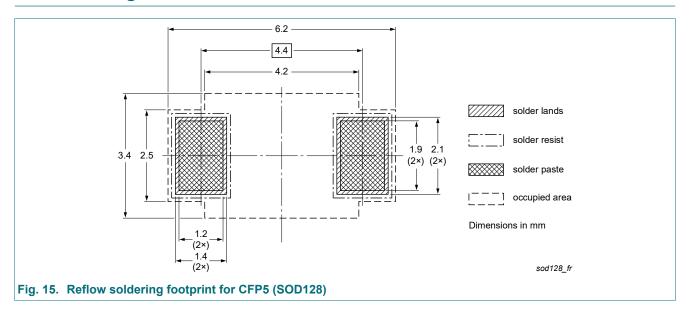
## **Quality information**

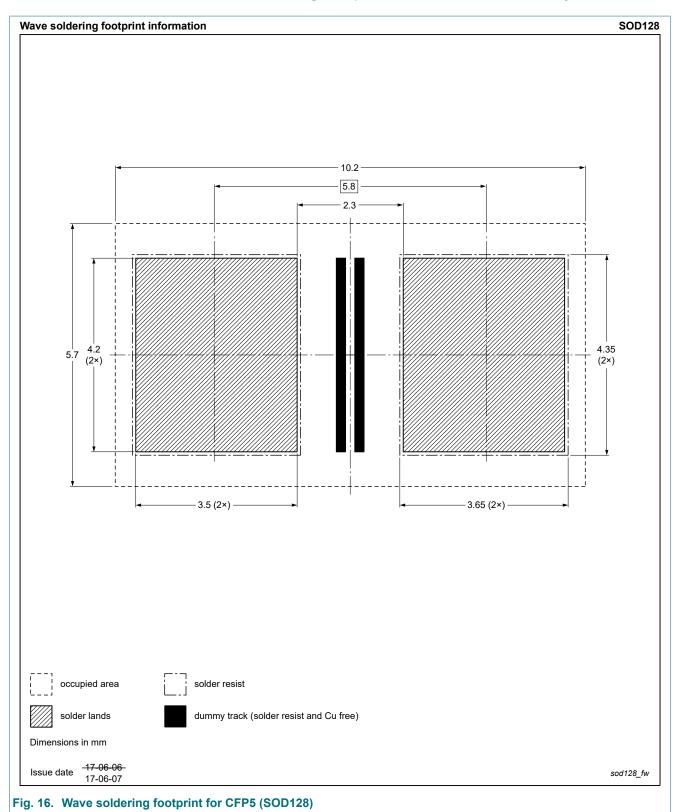
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 12. Package outline



# 13. Soldering





# 14. Revision history

### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes					
PMEG4030ETP-Q v.2	20230220	Product data sheet	-	PMEG4030ETP-Q v.1					
Modifications:	_	<ul> <li>Limiting values: Measurement conditions for I<sub>FSM</sub> changed from square wave to half-sine wave.</li> </ul>							
PMEG4030ETP-Q v.1	20210719	Product data sheet	-	-					

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# 15. Legal information

### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PMEG4030ETP-Q

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